

Title (en)

COMPOSITION AND METHOD FOR TREATING WATER SYSTEMS

Title (de)

ZUSAMMENSETZUNG UND VERFAHREN ZUR BEHANDLUNG VON WASSERSYSTEMEN

Title (fr)

COMPOSITION ET PROCÉDÉ DE TRAITEMENT DE SYSTÈMES D'EAU

Publication

**EP 3065889 A2 20160914 (EN)**

Application

**EP 14859612 A 20141105**

Priority

- US 201314073705 A 20131106
- US 201462010042 P 20140610
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- US 2014063996 W 20141105

Abstract (en)

[origin: WO2015069684A2] A solid composition for treating cooling or heated water systems to remove scale, microorganisms and biofilm, and corrosion by-products. The composition for cooling towers and chilled water systems comprises chelating agents and an anionic surfactant. The composition for boilers and heated water systems comprises a sulfite, neutralizing amines, sodium phosphate, and, optionally, a polymethacrylate or polyacrylate polymer. A method for using such a treatment composition comprises contacting the treatment composition with substantially all parts of the water system.

IPC 8 full level

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CPC (source: EP MX)

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